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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/585,522	07/07/2006	Nobuyuki Morimoto	SHX 367	4528
	7590 07/17/2007	EXAMINER		
KOLISCH HARTWELL, P.C. 200 PACIFIC BUILDING 520 SW YAMHILL STREET PORTLAND, OR 97204			DINH, THU HUONG T	
			ART UNIT	PAPER NUMBER
			2812	
			MAIL DATE	DELIVERY MODE
			07/17/2007	· ♥ PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		$\mathcal{S}\mathcal{H}$
	Application No.	Applicant(s)
	10/585,522	MORIMOTO ET AL.
Office Action Summary	Examiner	Art Unit
	Thu-Huong Dinh	2812
The MAILING DATE of this communication Period for Reply	appears on the cover sheet w	ith the correspondence address
A SHORTENED STATUTORY PERIOD FOR REWHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communication of the Information of the Informat	R 1.136(a). In no event, however, may a late of the community of the commu	CATION. Teply be timely filed ITHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).
Status		
1)	This action is non-final. wance except for formal mate	•
Disposition of Claims		
 4) Claim(s) 1-4 is/are pending in the application 4a) Of the above claim(s) is/are with 5) Claim(s) is/are allowed. 6) Claim(s) 1-4 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction are 	drawn from consideration.	
Application Papers		
9) The specification is objected to by the Exam	niner.	
10) The drawing(s) filed on is/are: a)	•	
Applicant may not request that any objection to		
Replacement drawing sheet(s) including the co	·	
Priority under 35 U.S.C. § 119 12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum 2. Certified copies of the priority docum 3. Copies of the certified copies of the application from the International Bu * See the attached detailed Office action for a	nents have been received. nents have been received in A priority documents have been reau (PCT Rule 17.2(a)).	pplication No received in this National Stage
Attachment(s)		
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date <u>9/26/2006,7/7/2006</u>.) Paper No(Summary (PTO-413) s)/Mail Date nformal Patent Application

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DETAILED ACTION

Priority

1. The foreign priority claim filed on 1/8/2004 was not entered because the foreign priority claim was not filed during the time period set forth in 37 CFR 1.55(a)(1). For original applications filed under 35 U.S.C. 111(a) (other than a design application) on or after November 29, 2000, the time period is during the pendency of the application and within the later of four months from the actual filing date of the application or sixteen months from the filing date of the prior foreign application. For applications that have entered national stage from an international application filed on or after November 29, 2000, after compliance with 35 U.S.C. 371, the claim for priority must be made during the pendency of the application and within the time limit set forth in the PCT and the Regulations under the PCT. See 37 CFR 1.55(a)(1)(ii). If applicant desires priority under 35 U.S.C. 119(a)-(d), (f) or 365(a) based upon a prior foreign application, applicant must file a petition for an unintentionally delayed priority claim (37 CFR 1.55(c)). The petition must be accompanied by (1) the claim (i.e., the claim required by 35 U.S.C. 119(a)-(d) and (f) and 37 CFR 1.55) for priority to the prior foreign application, unless previously submitted; (2) a surcharge under 37 CFR 1.17(t); and (3) a statement that the entire delay between the date the claim was due under 37 CFR 1.55(a)(1) and the date the claim was filed was unintentional. The Director may require additional information where there is a question whether the delay was unintentional. The petition should be addressed to: Mail Stop Petition, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 1-4 are rejected under 35 U.S.C. 102(b) as being anticipated by Murakami et al. (U.S. 2006/0177991 filed February 6, 2006).

Murakami et al. teach the following: 1)...A process for producing an SOI wafer (col. 3, [0033] and Fig. 2) in which an ion implantation layer (4) is formed via an insulating film (3) on a wafer (1) that is to be used as an active layer (1) by implanting ions of hydrogen (col. 3, [0037] and Step 3 of Fig. 2) or a rare gas element, the wafer for the active layer (1) is then bonded via an insulating film (3) on a base wafer (2) so as to form a bonded wafer (Col. 3, [0038] and step 4 of Fig. 2), and the bonded wafer is then heat processed and is cleaved with the ion implantation layer taken as a boundary (col. 3, [0040]), wherein after the SOI wafer has been formed by heat processing the bonded wafer and then cleaving it off taking the ion implantation layer as a boundary (Step 5 of Fig. 2), oxidization processing is performed on the SOI wafer (7) so that an oxide film (8) having a predetermined thickness is formed on the surface of the SOI layer (col. 3, [0041]), this oxide film (8) is then removed (col. 4, [0044] and Step 7 of Fig. 2), and the SOI wafer is subsequently heat treated in an inert gas atmosphere (col. 4, [0045] and Step 8 of Fig. 2); 2)...wherein, in the heat processing in the inert gas atmosphere, the SOI wafer is held for approximately three hours or more at a temperature of 1100 °C or more in an

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argon gas atmosphere (col. 4, [0045] and [0046]) (Claim 2); 3)...wherein the oxidization processing is performed at a temperature of 600 °C to 1000 °C (col. 3, [0042]) (Claim 3); 4)...wherein the oxide film has a thickness of 4000A (col. 3, [0041]) (Claim 4).

Given the teaching of the references, it would have been obvious to determine the optimum thickness, temperature as well as condition of delivery of the layers involved. See In re Aller, Lacey and Hall (10 USPQ 233-237) It is not inventive to discover optimum or workable ranges by routine experimentation. Note that the specification contains no disclosure of either the critical nature of the claimed ranges or any unexpected results arising therefrom. Where patentability is said to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. In re Woodruff, 919 f.2d 1575,1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

Conclusion

4. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Endo et al. (U.S.2007/0069335 filed September 8, 2004) teach Bonded Wafer and Its Manufacturing Method.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thu-Huong Dinh whose telephone number is 571 272-9014. The examiner can normally be reached on Monday through Friday (8:30AM-5:00PM Eastern).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Lebentritt can be reached on 571 272-1873. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Thd 7/6/2007

HAMARY EXAMINER